LPDDR5(X) Interposers

315-Ball | Direct Attach | XH Series

OVERVIEW

The LP5-A-CDA-315 interposer enables probing of a LPDDR5/LPDDR5X, 315ball, 2x16 memory component at the ball grid array (BGA) with an oscilloscope or analyzer.

KEY FEATURES

- LPDDR5 / LPDDR5X, 315-ball, 2x16
- Easily access all signals
- Probe with an oscilloscope or analyzer
- XH Series
- 315-ball, 2x16
- Embedded tap resistors
- Small keep-out volume (KOV)
- Risers available
- Includes s-parameters for system simulation
- Also includes oscilloscope de-embedding s-parameters
- Install with standard BGA rework
- Attachment and analysis services available

BGA INTERPOSER ADVANTAGES

This LPDDR5 BGA interposer provides complete signal access for probing with either an oscilloscope or an MA51x0 series analyzer. The interposer may be used with a riser to elevate the interposer and clear adjacent components. Both the interposer and riser are easy to install using standard BGA rework practices. Or take advantage of Nexus' attachment and testing services.

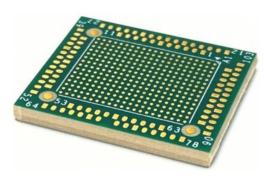
OSCILLOSCOPES, ANALYZERS, AND PROBES

The oscilloscope requirements will differ based on the frequency content of the LPDDR5(X) bus signals. Bandwidths around 12 – 16 GHz may be a sufficient, general-purpose solution. However, for the highest speeds of LPDDR5X, 16 – 30 GHz bandwidths are required.

This LP5-A-CDA-315 interposer is may also be used with a MA5100 series analyzer to enable advanced oscilloscope cross-triggering, protocol debug, and protocol compliance analysis. A PRB-FL flying-lead probe is required. Alternately, a LP5-D-CDA-315 interposer may be used which provides solder-free, high-density analyzer connections using a PRB-HD-10 analyzer probe.



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ATTACHMENT & TESTING SERVICES

The following services are available for this interposer.

ATTACHMENT SERVICE

For each interposer, the *Attachment Service* will install a component to the interposer and the interposer to the target. Other accessories may also be attached.

TARGET BOOT & BASIC FUNCTIONALITY

For each target, this service will power on and ensure functionality of the target after the attachment service is completed.

ADDITIONAL / CUSTOM SERVICE

Additional and custom services are also available. Please contact us for more information.

SIGNAL MAPPING

Pad #	Signal	Pad #	Signal	Pad #	Signal	Pad #	Signal
1	GROUND	27	GROUND	53	GROUND	79	GROUND
2	DQ2_A	28	GROUND	54	DQ2_B	80	DQ14_A
3	CS1_A	29	DQ14_B	55	CS1_B	81	RDQS1_t_A
4	CA2_A	30	RDQS1_t_B	56	CA2_B	82	RDQS1_c_A
5	CS0_A	31	RDQS1_c_B	57	CS0_B	83	DQ11_A
6	GROUND	32	DQ11_B	58	GROUND	84	GROUND
7	CK_c_B	33	GROUND	59	CK_c_A	85	DQ3_A
8	CK_t_B	34	DQ3_B	60	CK_t_A	86	RDQS0_c_A
9	CA4_B	35	RDQS0_c_B	61	CA4_A	87	RDQS0_t_A
10	DQ10_B	36	RDQS0_t_B	62	DQ10_A	88	DQ6_A
11	GROUND	37	DQ6_B	63	GROUND	89	GROUND
12	GROUND	38	GROUND	64	GROUND	90	GROUND
13	DQ1_A	39	GROUND	65	DQ1_B	91	WCK1_t_A
14	DQ0_A	40	WCK1_t_B	66	DQ0_B	92	WCK1_c_A
15	DQ7_A	41	WCK1_c_B	67	DQ7_B	93	DQ13_A
16	CA0_A	42	DQ13_B	68	CA0_B	94	GROUND
17	GROUND	43	GROUND	69	GROUND	95	DMI1_A
18	CA1_A	44	DMI1_B	70	CA1_B	96	DQ12_A
19	RESET_n	45	DQ12_B	71	CA5_A	97	DQ4_A
20	CA5_B	46	DQ4_B	72	CA3_A	98	DMI0_A
21	CA3_B	47	DMI0_B	73	GROUND	99	GROUND
22	GROUND	48	GROUND	74	CA6_A	100	DQ5_A
23	CA6_B	49	DQ5_B	75	DQ15_A	101	WCK0_c_A
24	DQ15_B	50	WCK0_c_B	76	DQ8_A	102	WCK0_t_A
25	DQ8_B	51	WCK0_t_B	77	DQ9_A	103	GROUND
26	DQ9_B	52	GROUND	78	GROUND		

Figure 1 LP5-A-CDA-315 Signals Probed

DIMENSION DRAWINGS

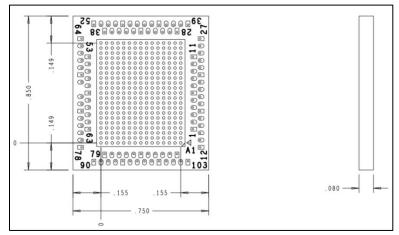


Figure 2 LP5-A-CDA-315 Dimensions

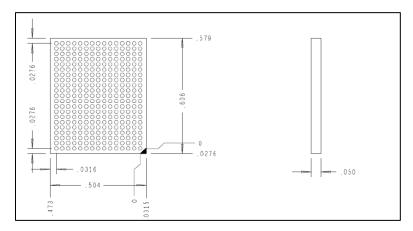


Figure 3 LP5-RSR-315 Dimensions

PRODUCT CONFIGURATION TABLE

Product Name	Description	Nexus Order Number
LP5-A-CDA-315	LPDDR5 315-Ball Direct Attach Interposer	NEX-LP5MCI315XHSCDS
LP5-RSR-315	LPDDR5 315-Ball Riser	NEX-RSRLPDDR5315



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